



# PARA LIGHT ELECTRONICS CO., LTD.

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# DATA SHEET

PART NO.:L-C295JRLBCT-5A-U1

REV: <u>A / 0</u>

CUSTOMER'S APPROVAL:	DCC:		
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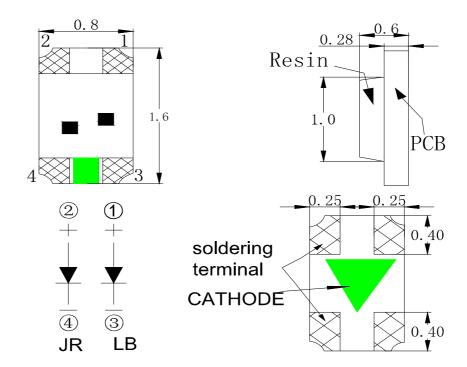




Part No.:L-C295JRLBCT-5A-U1

REV:A/0

### PACKAGE OUTLINE DIMENSIONS



#### Note:

- 1. All dimensions are in millimeters.
- 2. Tolerance is  $\pm$  0.1mm (.004") unless otherwise noted

#### Features

- \* Dual color, top view, wide view angle Chip LED.
- \* Package in 8mm tape on 7" diameter reels.
- \* Compatible with automatic Pick & Place equipment.
- \* Compatible with Reflow soldering and Wave soldering processes.
- \* EIA STD package.
- \* I.C. compatible.
- \* Pb free product.

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# Chip Materials

chip	Light Color	Dice Material	Lens Color
JR	Red	AlInGap	Water Clear
LB	Blue	InGaN	Water Clear

# ● Absolute Maximum Ratings (Ta=25°C)

Symbol Parameter -		Rating		Unit	
		Red	Blue	Unit	
PD	Power Dissipation	75	100	mW	
Ipf	Peak Forward Current		100	m A	
IPF	(1/10 Duty Cycle, 0.1ms Pulse Width)	80	100	mA	
IF	Continuous Forward Current	25	25	mA	
-	De-rating Linear From 25°C	0.25	0.25	mA/°C	
VR	Reverse Voltage 5 5		5	V	
ESD	Electrostatic Discharge Threshold (HBM) <sup>Note A</sup>	2000 1000		V	
Topr	Operating Temperature Range $-40 \sim +85$		$^{\circ}\!\mathbb{C}$		
Tstg	Storage Temperature Range	-40 ~ +85		$^{\circ}\!\mathbb{C}$	
-	Wave Soldering Condition (Two times Max.)	260 (for 5 seconds)		$^{\circ}\!\mathbb{C}$	

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

# • Electro-Optical Characteristics (Ta=25°C)

SYM	BOL	PARAMETER TEST CONDITION		MIN.	TYP.	MAX.	UNIT			
VF	Red	Forward Voltage	IF = 5mA		1.8	2.2	V			
VE	Blue	Troiward voitage	IF - SINA		2.7	3.0	<b>'</b>			
IV	Red	II uminous Intensity		7.1	12		mcd			
10	Blue			11.2	40					
20	1/2	Half Intensity Angle	IF = 5mA		130		deg			
λD	Red	Dominant Wavelength	IF = 5mA		631		nm			
, KD	Blue	Borninant vvavelength	II OIII/ (		470					
λр	Red	Peak Emission Wavelength	IF = 5mA		639		nm			
Λρ	Blue	l eak Emission wavelength	II – JIIIA		468					
Δ.	Red	Connection   Line   Lin		Connection of Lote Middle	Spectral Line Half Width			25		nm
ΔΛ	$\Delta \lambda$ Blue Spectral Line Half-Width IF = 5mA			17						
IR	Red Reverse Current VR = 5V				10	^				
IK	Blue	Neverse Current	VK - 3V			50	μΑ			

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### Bin Code List

Luminous Intensity (IV), Unit: mcd@5mA					
Red			Red Blue		
Bin Code	Min	Max	Bin Code	Min	Max
K	7.1	11.2	L	11.2	18
L	11.2	18	M	18	28
M	18	28	N	28	45
N	28	45			

Tolerance of each bin are  $\pm 15\%$ 

Forward Voltage(VF), Unit:V@5mA			
Blue			
Bin Code	Min	Max	
11	2.6	2.7	
12	2.7	2.8	
13	2.8	2.9	
14	2.9	3.0	

Tolerance of each bin are  $\pm 0.1$ Volt

Dominant Wavelength (Hue), Unit: nm@5mA			
Blue			
Bin Code	Min	Max	
AC	465	470	
AD	470	475	

Tolerance of each bin are  $\pm 1$ nm

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#### Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2.  $\theta$  1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:
  - Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

## Typical Electro-Optical Characteristics Curves

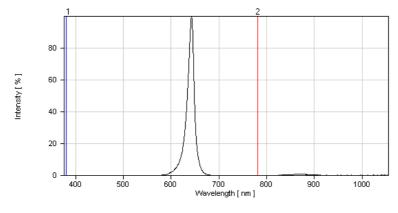


Fig.1 Red Relative Intensity vs. Wavelength

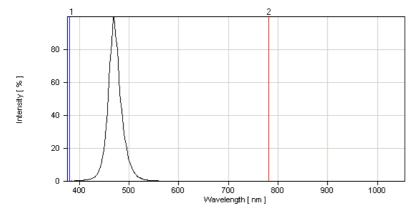


Fig. 1 Blue Relative Intensity vs. Wavelength

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# Red Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

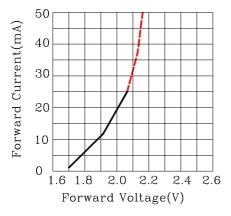
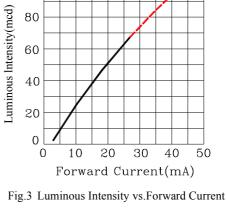


Fig.2 Forward Current vs.Forward Voltage



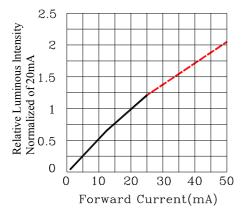


Fig.4 Relative Luminous Intensity vs.Forward Current

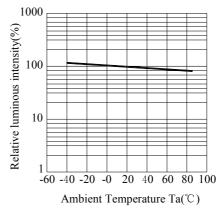


Fig.5 Luminous Intensity vs. Ambient Temperature

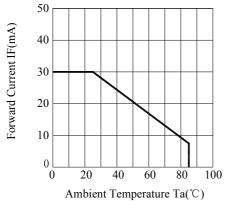


Fig.6 Forward Current Derating Curve

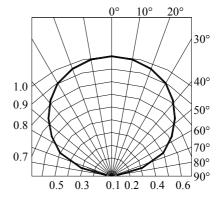


Fig.7 Relative Intensity vs. Angle

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# Blue Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

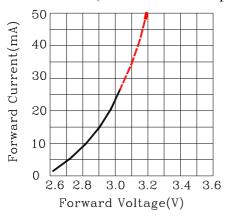


Fig.2 Forward Current vs.Forward Voltage

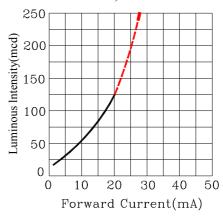


Fig.3 Luminous Intensity vs.Forward Current

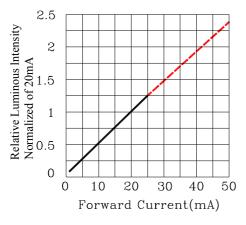


Fig.4 Relative Luminous Intensity vs.Forward Current

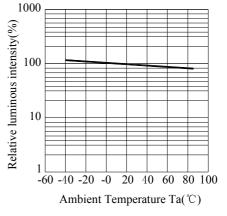


Fig.5 Luminous Intensity vs. Ambient Tempera

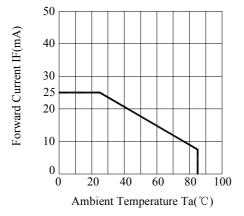


Fig.6 Forward Current Derating Curve

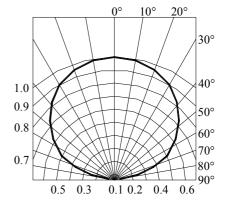


Fig.7 Relative Intensity vs. Angle

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## Label Explanation



ITEM CODE:PARA LIGHT

PART NO:L-C295JRLBCT-5A-U1

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110

A B C D E F

A---EM: Emos Code

B---S:SMD

C---Local

D---Year

E---Month

F---SPEC.

#### PACKING QUANTITY OF BAG:

3000pcs for 150, 170, 110, 155, 115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE: 2012 09 10

G H I

G---- Year

H--- Month

I --- Day

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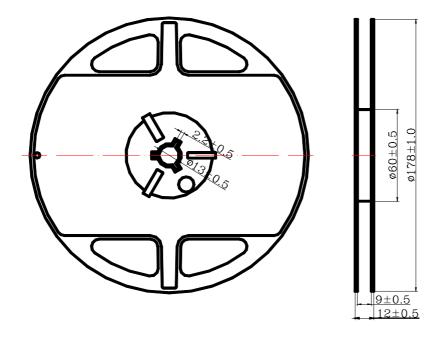




Part No.:L-C295JRLBCT-5A-U1

REV:A/0

## Reel Dimensions



#### Notes:

- 1. Taping Quantity: 4000pcs
- 2. The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5^{\circ}$ , Unit: mm.

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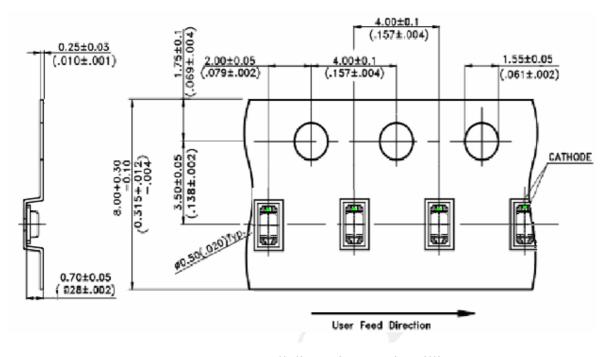




Part No.:L-C295JRLBCT-5A-U1

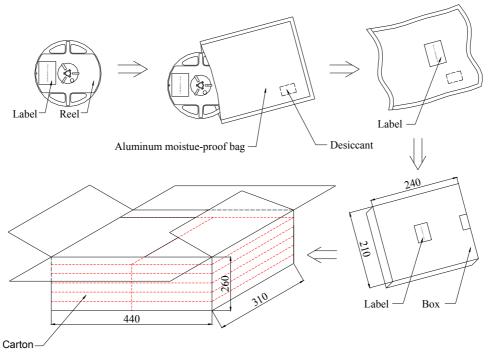
REV:A/0

Package Dimensions Of Tape And Reel



Notes: All dimensions are in millimeters.

# Moisture Resistant Packaging



Notes: One reel in a bag, six bag in a inner box, six inner boxes in a carton. Unit: mm

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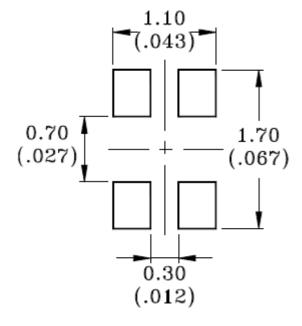
Part No.:L-C295JRLBCT-5A-U1

REV:A/0

## Cleaning

- \* If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- \* Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- \* Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

# Suggest Soldering Pad Dimensions



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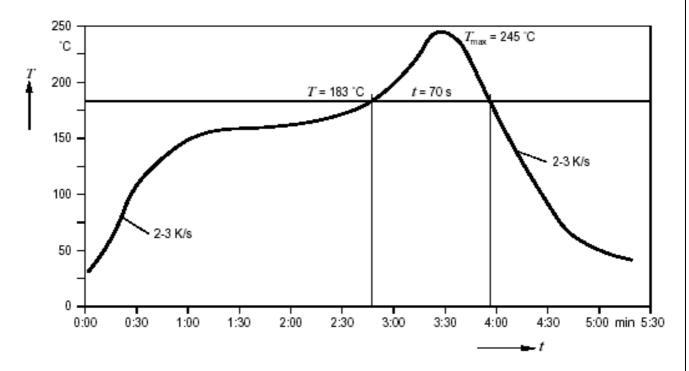




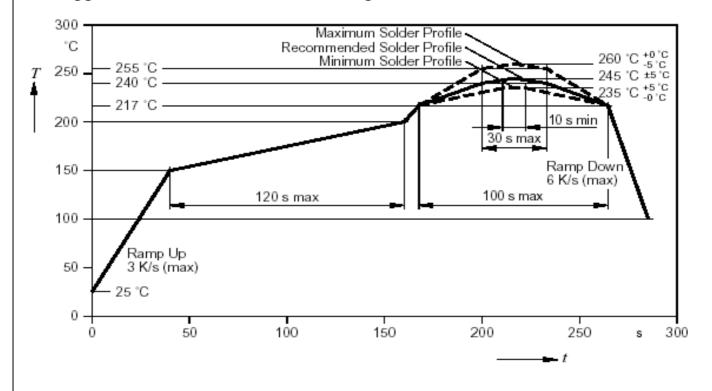
Part No.:L-C295JRLBCT-5A-U1

REV:A/0

• Suggest Sn/Pb IR Reflow Soldering Profile Condition:



• Suggest Pb-Free IR Reflow Soldering Profile Condition:



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REV:A/0

### CAUTIONS

#### 1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

#### 2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours.

#### 3. Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time: 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300°C Max., Soldering time: 3 sec. Max.(one time only), power dissipation of iron: 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering. Wave soldering:

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

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## SURFACE MOUNT DEVICE LED

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### 4. Lead-Free Soldering

### For Reflow Soldering:

- 1 · Pre-Heat Temp:150-180°C,120sec.Max.
- 2 · Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3 · Peak Temperature: 260°C , 5sec.
- 4 · Reflow Repetition:2 Times Max.
- 5 · Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

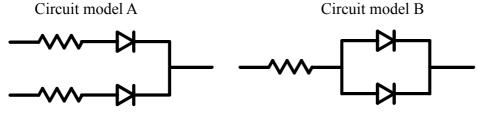
### For Soldering Iron (Not Recommended):

- 1 · Iron Tip Temp:350°C Max.
- 2 Soldering Iron:30w Max.
- 3 · Soldering Time: 3 Sec. Max. One Time.

#### For Dip Soldering:

- 1 \ Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2 · Bath Temp:265°C Max.
- 3 \ Dip Time: 5 Sec. Max.

#### 5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

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## 6.Reliability Test

Classification	Test Item	Test Condition	Reference Standard		
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D: 1026 (1995) MIL-STD-883D: 1005 (1991) JIS C 7021:B-1 (1982)		
Endurance Test	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F: 103B(1980) JIS C 7021: B-11 (1982)		
	High Temperature Ta= 105±5°C Storage Test Time= 1000HRS (-24HRS, 72HRS)		MIL-STD-883D: 1008 (1991) JIS C 7021:B-10 (1982)		
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS, 72H RS)	JIS C 7021:B-12 (1982)		
Environmental Test	Temperature Cycling	105±5℃ -55±5℃ 10mins 10mins 100 Cycles	MIL-STD-202F: 107D (1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1010 (1991) JIS C 7021: A-4 (1982)		
	Thermal Shock	IR-Reflow In-Board, 2 Times         105±5 °C       -55 °C±5 °C         10mins       10mins       100 Cycles	MIL-STD-202F: 107D(1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1011(1991)		
	Solder Resistance	Tsol= $260 \pm 5^{\circ}$ C Dwell Time= $10 \pm 1$ sec	MIL-STD-202F: 210A(1980) MIL-STD-750D: 2031(1995) JIS C 7021: A-1 (1982)		
	Solder ability	Tsol= $235 \pm 5$ °C Immersion time $2\pm0.5$ sec Immersion rate $25\pm2.5$ mm/sec Coverage ≥95% of the dipped surface	MIL-STD-202F: 208D(1980) MIL-STD-750D: 2026(1995) MIL-STD-883D: 2003(1991) IEC 68 Part 2-20 JIS C 7021: A-2 (1982)		

## 7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

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